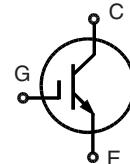


High Voltage IGBT with optional Diode

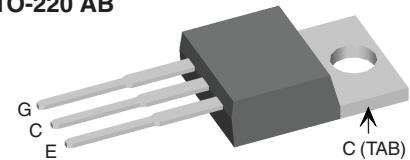
Replacement
IXYP20N65B3

V_{CES} = 600 V
 I_{C25} = 32 A
 $V_{CE(sat)\text{ typ}}$ = 2.2 V

High Speed,
Low Saturation Voltage



TO-220 AB



G = Gate,
C = Collector ,
TAB = Collector

Symbol	Conditions	Maximum Ratings		
V_{CES}	$T_J = 25^\circ\text{C}$ to 150°C	600	V	
V_{CGR}	$T_J = 25^\circ\text{C}$ to 150°C ; $R_{GE} = 20 \text{ k}\Omega$	600	V	
V_{GES}	Continuous	± 20	V	
V_{GEM}	Transient	± 30	V	
I_{C25}	$T_c = 25^\circ\text{C}$	32	A	
I_{C90}	$T_c = 90^\circ\text{C}$	20	A	
I_{CM}	$T_c = 90^\circ\text{C}$, $t_p = 1 \text{ ms}$	40	A	
RBSOA	$V_{GE} = \pm 15 \text{ V}$, $T_j = 125^\circ\text{C}$, $R_G = 22 \Omega$ Clamped inductive load, $L = 30 \mu\text{H}$	$I_{CM} = 60$ $V_{CEK} < V_{CES}$	A	
t_{sc} (SCSOA)	$V_{GE} = \pm 15 \text{ V}$, $V_{CE} = 600 \text{ V}$, $T_j = 125^\circ\text{C}$ $R_G = 22 \Omega$, non repetitive	10	μs	
P_c	$T_c = 25^\circ\text{C}$	IGBT Diode	140 50	W W
T_j			-55 ... +150	$^\circ\text{C}$
T_{stg}			-40 ... +150	$^\circ\text{C}$
Maximum lead temperature for soldering 1.6 mm (0.062 in.) from case for 10 s			300	$^\circ\text{C}$
M_d	Mounting torque		0.4 - 0.6	Nm
Weight			2	g

Features

- NPT IGBT technology
- low switching losses
- low tail current
- no latch up
- short circuit capability
- positive temperature coefficient for easy paralleling
- MOS input, voltage controlled
- optional ultra fast diode
- International standard package

Advantages

- Space savings
- High power density

Typical Applications

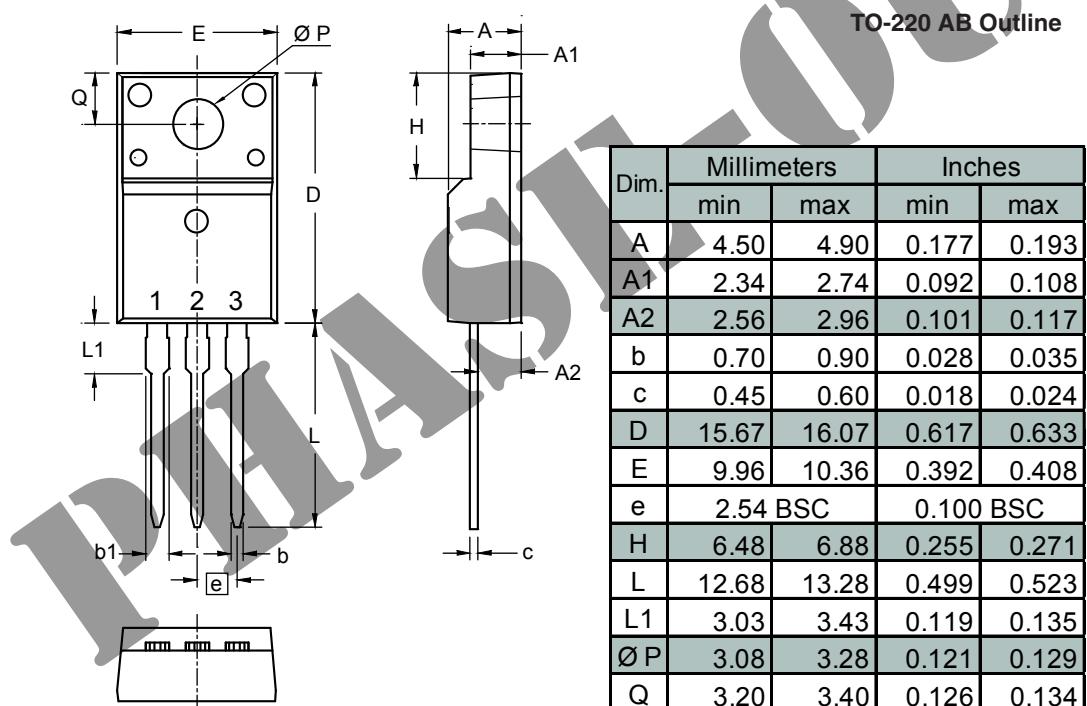
- AC motor speed control
- DC servo and robot drives
- DC choppers
- Uninterruptible power supplies (UPS)
- Switch-mode and resonant-mode power supplies

Symbol	Conditions	Characteristic Values		
		($T_j = 25^\circ\text{C}$, unless otherwise specified)	min.	typ.
$V_{(BR)CES}$	$V_{GE} = 0 \text{ V}$	600		V
$V_{GE(\text{th})}$	$I_C = 0.4 \text{ mA}$, $V_{CE} = V_{GE}$	3		V
I_{CES}	$V_{CE} = V_{GES}$	$T_j = 25^\circ\text{C}$	0.7	0.1 mA
		$T_j = 125^\circ\text{C}$		mA
I_{GES}	$V_{CE} = 0 \text{ V}$, $V_{GE} = \pm 20 \text{ V}$		± 500	nA
$V_{CE(\text{sat})}$	$I_C = 20 \text{ A}$, $V_{GE} = 15 \text{ V}$	2.2	2.8	V

IXYS reserves the right to change limits, test conditions and dimensions.

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Symbol	Conditions	Characteristic Values ($T_J = 25^\circ\text{C}$, unless otherwise specified)		
		min.	typ.	max.
C_{ies}		800	pF	
C_{oes}	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$	85	pF	
C_{res}		50	pF	
Q_g	$I_C = 20 \text{ A}, V_{GE} = 15 \text{ V}, V_{CE} = 480 \text{ V}$	70	nC	
$t_{d(on)}$		25	ns	
t_r		30	ns	
$t_{d(off)}$	Inductive load, $T_J = 125^\circ\text{C}$	260	ns	
t_f	$I_C = 20 \text{ A}, V_{GE} = \pm 15 \text{ V}, V_{CE} = 300 \text{ V}, R_G = 22 \Omega$	55	ns	
E_{on}		0.9	mJ	
E_{off}		0.4	mJ	
R_{thJC}	Package with heatsink compound	0.5		0.9 K/W
R_{thCH}	Package with heatsink compound	0.25		K/W



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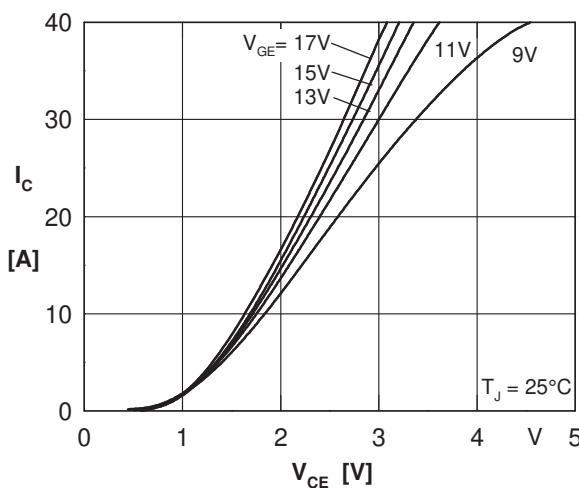


Fig. 1 Typ. output characteristics

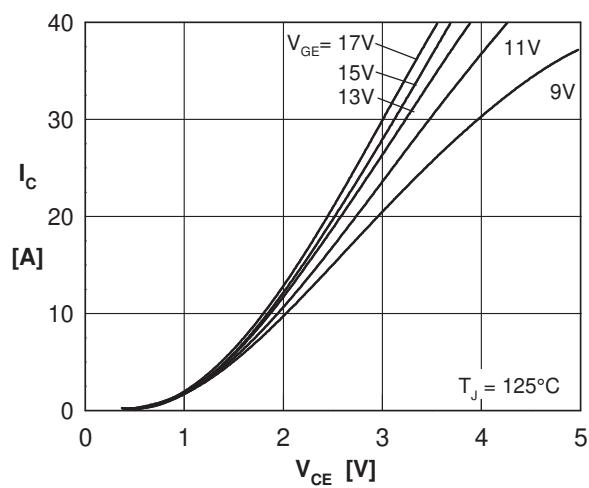


Fig. 2 Typ. output characteristics

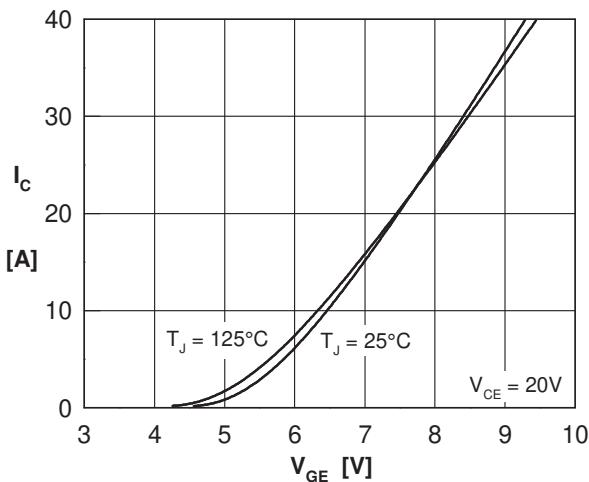


Fig. 3 Typ. transfer characteristics

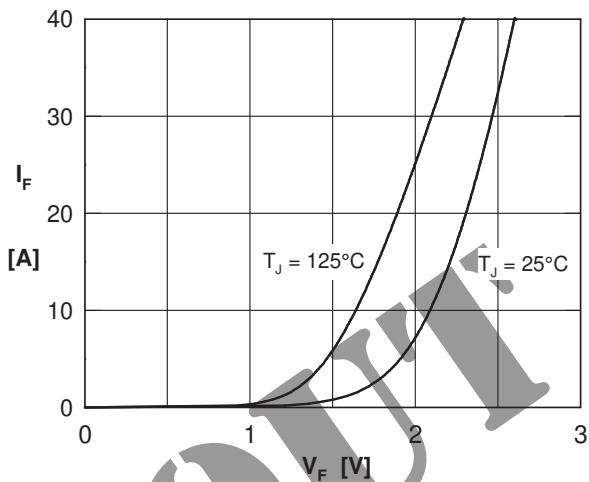


Fig. 4 Typ. forward characteristics of free wheeling diode

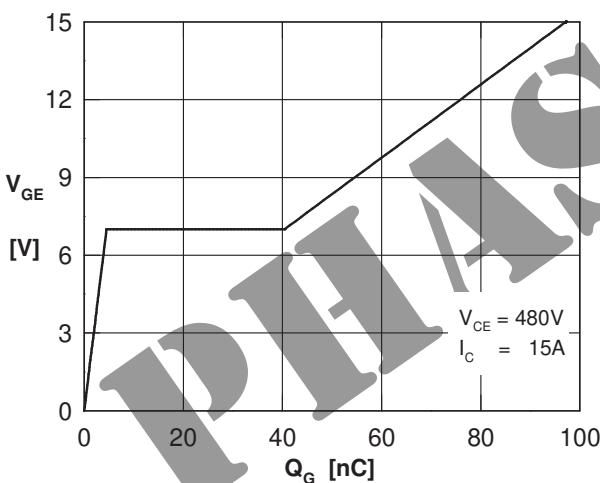


Fig. 5 Typ. turn on gate charge

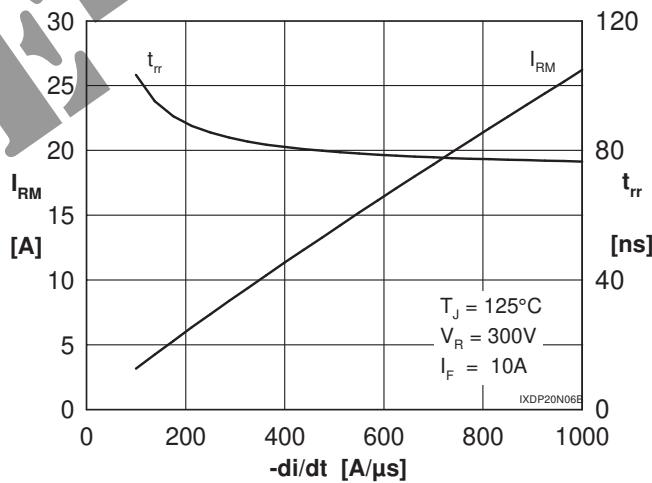


Fig. 6 Typ. turn off characteristics of free wheeling diode

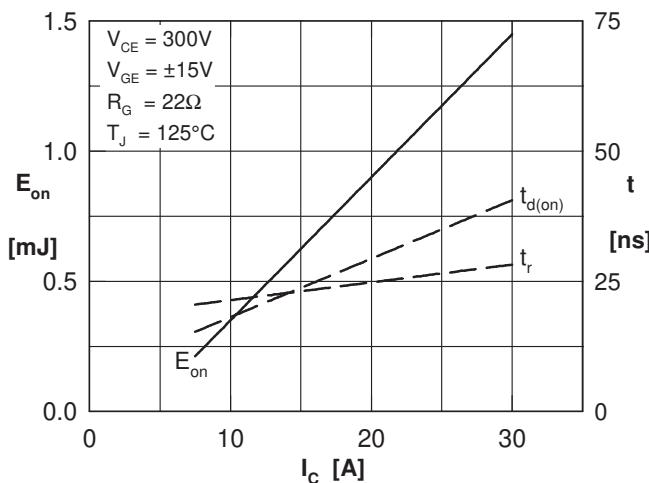


Fig. 7 Typ. turn on energy and switching times versus collector current

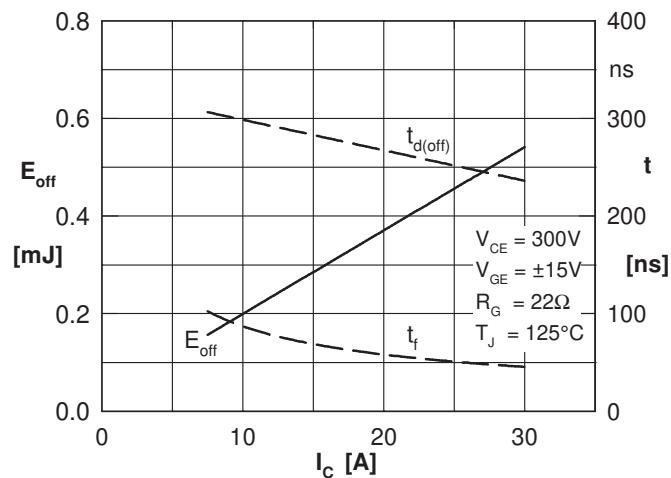


Fig. 8 Typ. turn off energy and switching times versus collector current

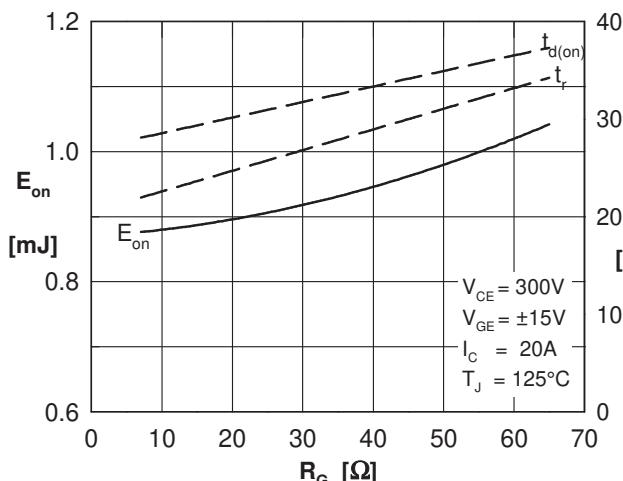


Fig. 9 Typ. turn on energy and switching times versus gate resistor

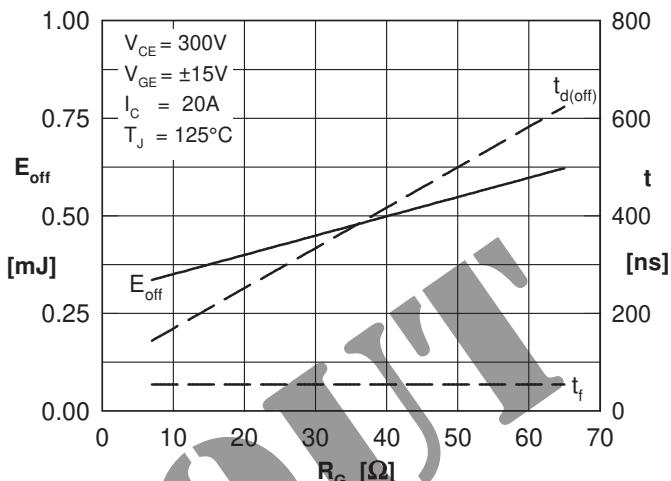


Fig. 10 Typ. turn off energy and switching times versus gate resistor

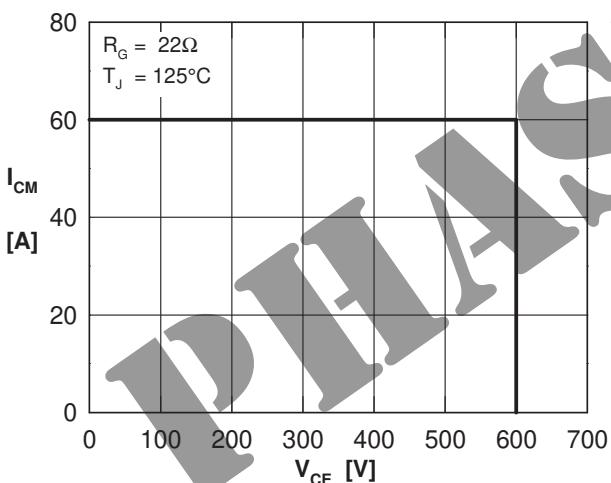


Fig. 5 Typ. turn on gate charge

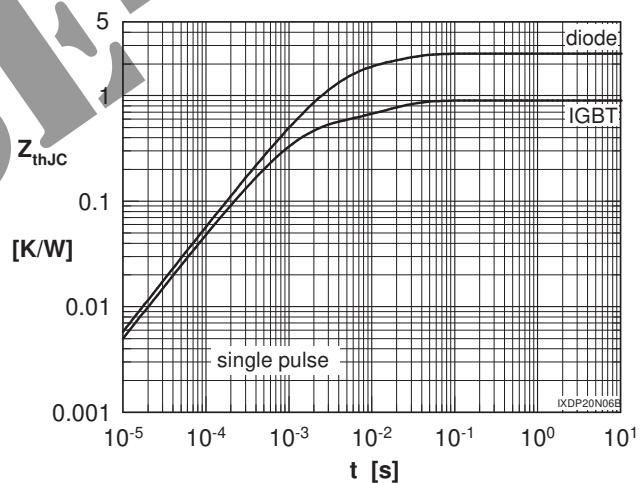


Fig. 6 Typ. turn off characteristics of free wheeling diode